

# LED Resistors (Z-Foil) (LED1625 and LED221)

## Ultra High Precision LED Bulk Metal<sup>®</sup> Foil Resistors Rating to 8W, TCR of ±0.2 ppm/°C and Stability of ±0.005%

### FEATURES AND BENEFITS

Temperature coefficient of resistance (TCR) (Table 1):
0.05 ppm/°C nominal (0°C to +60°C)

• ±0.2 ppm/°C nominal (-55°C to +125°C,+25°C ref.)

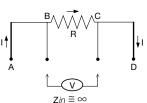
- Resistance range: **0.3**  $\Omega$  to **500**  $\Omega$  (for higher and lower values, please contact us)
- Bulk Metal Foil resistors are not restricted to standard values; we can supply specific "as required" values at no extra cost or delivery (e.g., 50R1234 vs. 50  $\Omega$ )
- Resistance tolerance: to ±0.01%
- Power coefficient "ΔR due to self heating": 5 ppm at rated power
- Load life stability: ±0.005% (50 ppm)
- Electrostatic discharge (ESD): at least to 25 kV
- Thermal stabilization time: <1 s (within 10 ppm of steady state value)
- Power rating: LED1625 to 1 W; LED221 to 8 W (Table 2)
- Non-inductive, non-capacitive design
- Rise time: 1 ns effectively no ringing
- Current noise: 0.010  $\mu V_{RMS}/V$  of applied voltage  ${<}{-}40~dB$
- Voltage coefficient: <0.1 ppm/V</li>
- Non-inductive: <0.08 µH
- Non hot spot design
- Thermal EMF: <0.05 μV/°C</li>
- · Low harmonic distortion, linear behavior
- LED221 is available with a solderable heat-sink tab (Ni/Tin-plated)

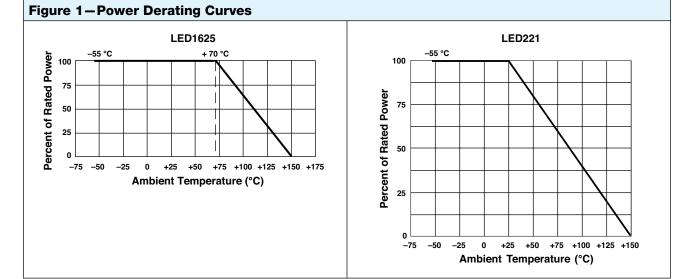


For improved LED brightness.

#### INTRODUCTION

In the modern LED-backed LCD, screen brightness is a very important function. The brightness is obtained by the LED panel mounted to the rear of the LCD, which controls brightness by boosting the input voltage connected to the panel. The input voltage usually comes from an Li-ion battery. A boost converter converts the Li-ion battery voltage to dozens of volts for the LED panel operation. To avoid brightness flickering and to control the stability of the LED output voltage, stable and precise current sense resistors with low thermal EMF and low absolute temperature coefficient of resistance are used.





#### Note

\* This datasheet provides information about parts that are RoHS-compliant and/or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS compliant. Please see the information/tables in this datasheet for details.

## New LED Resistors (LED1625 and LED221)



			(ppm/°C)	@ +70°C	Current <sup>(3)</sup>
	>2.0 to 10	±0.2%	0.2 ±2.8	1 W on FR4 PCB <sup>(4)</sup>	1.8 A
:		±0.5%			
LED1625		±1.0%			
	0.3 to 2.0	±0.5%			
		±1.0%			

Power, current – whichever is lower.
See solder pad loyout in Figure 5a

<sup>(4)</sup> See solder pad layout in Figure 5a.

Model Number	Resistance Range (Ω)	Tightest Tolerance <sup>(2)</sup> (%)	Nominal TCR and Max. Spread <sup>(1)</sup> (ppm/°C)
	0.5 to <1	±0.05%	±0.2 ±2.8
LED221	1 to <10	±0.02%	±0.2 ±2.3
	10 to 500	±0.01%	±0.2 ±1.8

#### THE LED PRECISION RESISTORS

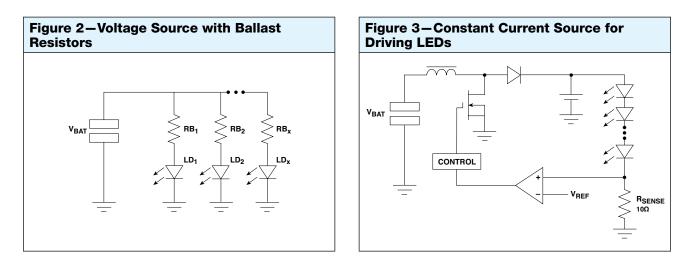
Direct control of current is provided by current sensing foil resistors. LEDs are current-driven devices whose brightness is proportional to their forward current. Forward current can be controlled in two ways. The first method is to use the LED V-I curve to determine what voltage needs to be applied to the LED to generate the desired forward current. This is typically accomplished by applying a voltage source and using a ballast resistor as shown in Figure 2. However, this method has several drawbacks. Any change in LED forward voltage creates a change in LED current. With a nominal forward battery voltage of 3.6 V, the LED in Figure 2 has 20 mA of current. If this voltage changes to 4.0 V, which is within the specified voltage tolerance due to temperature or manufacturing changes, the forward current drops to 14 mA. This 11% change in forward voltage causes a much larger 30 % change in forward current. Also, depending upon the available input voltage, the voltage drop and power dissipation across the ballast resistor waste power and reduce battery life.

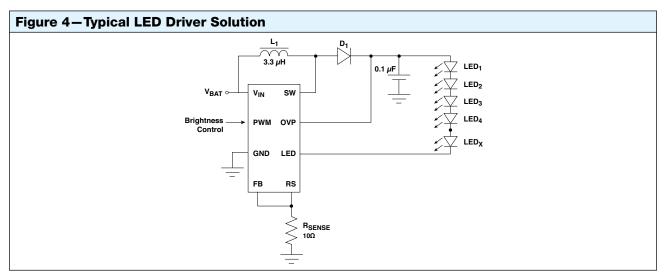
The second, preferred method of regulating LED current is to drive the LED with a constant current source. The constant current source eliminates changes in current due to variations in forward voltage, which translates into a constant LED brightness. Generating a constant current source is fairly simple. Rather than regulating the output voltage, the input power supply regulates the voltage across a current sense resistor. Figure 3 shows this implementation. The power supply reference voltage and the value of the current sense resistor determine the LED current. Multiple LEDs should be connected in a series configuration to keep an identical current flowing in each LED. Driving LEDs in parallel requires a ballast resistor in each LED string, which leads to lower efficiency and uneven current matching.

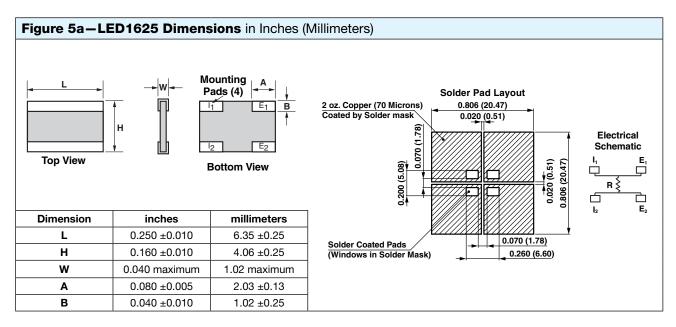
Battery life is critical in portable applications. For an LED driver to be useful, it must be efficient. Power efficiency is largely determined by the precision of the current sensing and brightness control. The amount of input power required to generate the desired LED brightness can be easily determined by dividing the power in the LEDs by the input power. Defining the efficiency in this way means that the power dissipated in the current sensing resistor contributes to the power lost in the power supply. Therefore, it is very important to use VPG's high-precision current sense resistors. In the case of a preferable and calculated value of 10  $\Omega$ , the best choice is the LED1625 or LED221 10  $\Omega$  resistor with 0.1% tolerance.

Figure 4 shows a typical LED driver application that drives a number of LEDs with 20 mA of forward current and operates from an input voltage range of 2.8 V to 6.0 V. The entire circuit consists of the control IC, two small ceramic capacitors, an inductor, a diode, and a 10  $\Omega$  current sense resistor. For this application, the LED1625 or LED221 10  $\Omega$  resistor would be ideal. This small circuit shows the high level of integration that is achieved with today's LED drivers. The primary power supply functions and the secondary features such as load disconnect, overvoltage protection, and PWM dimming have been implemented with a control IC and five small surface-mount passive components.









## New LED Resistors (LED1625 and LED221)



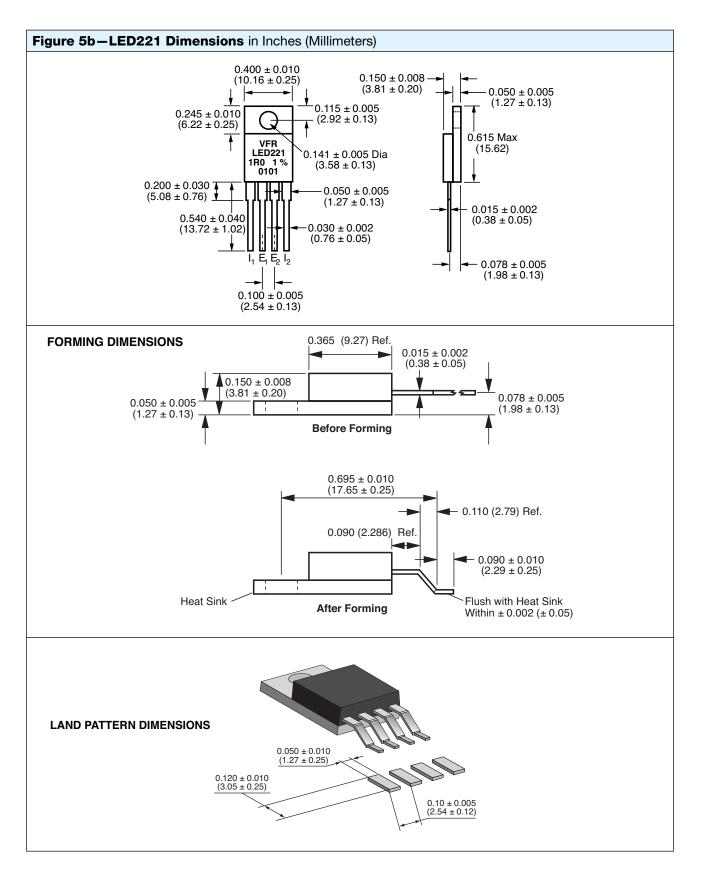




Table 2-LED221 Specifications				
Test or Condition	Performance			
Power rating at +25°C	8 W or 3 A <sup>(1)</sup> on heat sink <sup>(2)</sup> 1.5 W in free air			
Current noise	<0.010 µVRMS/V of applied voltage (-40 dB)			
High frequency operation Rise time Inductance <sup>(3)</sup> (L) Capacitance (C)	0.2 ns at 1 W 0.1 μH maximum: 0.03 μH typical <sup>(4)</sup> 1.0 pF maximum: 0.5 pF typical <sup>(4)</sup>			
Voltage coefficient (5)	<0.1 ppm/V			
Operating temperature range	–55°C to +150°C			
Maximum working voltage	300 V, not to exceed power rating			
Thermal EMF <sup>(6)</sup>	0.15 µV/°C maximum (lead effect)			
Weight	1.2 g maximum			

#### Notes

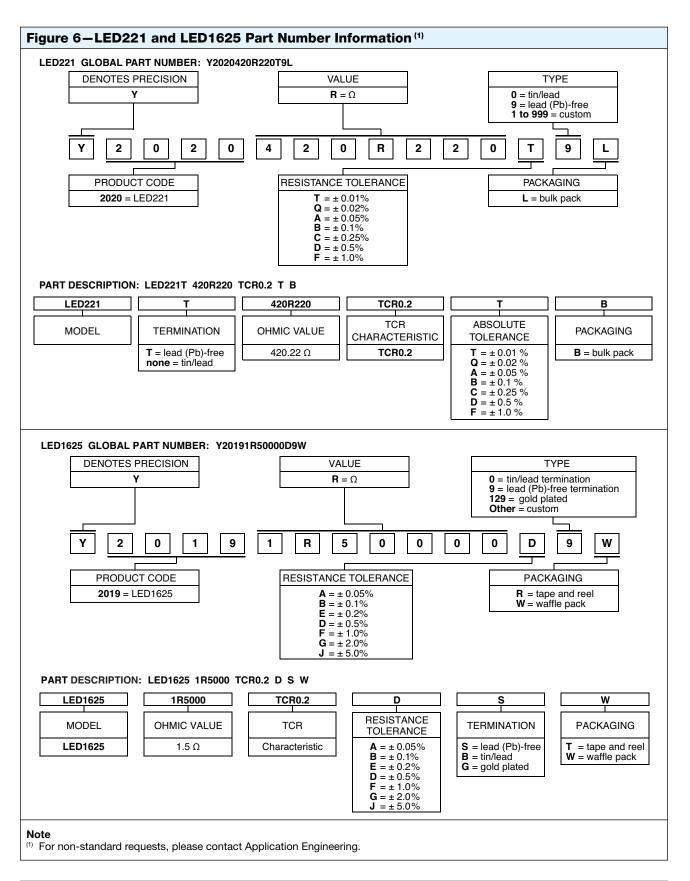
- <sup>(1)</sup> Whichever is lower.
- $^{(2)}\,$  Heat sink chassis dimensions are requirements per MIL-R-39009/1B:

Dimension	inches	millimeter
L	6.00	152.4
w	4.00	101.6
н	2.00	50.8
т	0.04	1.0

- <sup>(3)</sup> Inductance (L) mainly due to the leads.
- <sup>(4)</sup> Maximum is 1.0 % Á.Q.L. standard for all specifications except TCR.
- <sup>(5)</sup> The resolution limit of existing test requirement (within the measurement capability of the equipment, "essentially zero").
- $^{(6)}$   $\mu V/^{\circ}C$  relates to ÉMF due to lead temperature difference.

Table 3—Performance Specifications				
Test or Condition	<b>∆R Limits Typical</b>	△R Limits Max <sup>(1)</sup>		
LED1625				
Thermal shock, 5 x (-65°C to +150°C)	±0.005% (50 ppm)	±0.01% (100 ppm)		
Low temperature operation, -65°C, 45 min at Pnom	±0.005% (50 ppm)	±0.01% (100 ppm)		
Short time overload, 6.25 x rated power, 5 s	±0.005% (50 ppm)	±0.02% (200 ppm)		
High temperature exposure, +150°C, 100 h	±0.01% (100 ppm)	±0.02% (200 ppm)		
Resistance to soldering heat	±0.01% (100 ppm)	±0.03% (300 ppm)		
Moisture resistance	0.01% (100 ppm)	±0.03% (300 ppm)		
Load life stability, +70°C for 2000 h at 1 W	0.015% (150 ppm)	±0.025% (250 ppm)		
LED221				
Low temperature storage, 24 hours at -55°C	± 0.001 % (10 ppm)	± 0.002 % (20 ppm)		
Dielectric withstanding voltage, 300 V AC at Atm	± 0.001 % (10 ppm)	± 0.002 % (20 ppm)		
Dielectric withstanding voltage, 200 V AC at Brm	± 0.001 % (10 ppm)	± 0.002 % (20 ppm)		
Insulation resistance		$\pm 10^4 M\Omega$		
Low temperature operation	± 0.002 % (20 ppm)	±0.008% (80 ppm)		
Short time overload, 5 x rated power, 5 s (in air)	±0.001% (10 ppm)	± 0.002 % (20 ppm)		
Moisture resistance, +65°C to -10°C, 90 to 98 Rh, 10 days	±0.005% (50 ppm)	± 0.015 % (150 ppm)		
Terminal Strength	±0.001% (10 ppm)	± 0.002 % (20 ppm)		
Load life, +25°C for 2000 h with heat sink at 8 W	±0.005% (50 ppm)	± 0.015 % (150 ppm)		
Load life, +25°C for 2000 h in free air at 1.5 W	±0.005% (50 ppm)	± 0.015 % (150 ppm)		
High temperature exposure, +150°C	±0.005% (50 ppm)	±0.01% (100 ppm)		
Notes (1) Measurement error $\pm 0.001 \Omega$ .				







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